

J555-VB Datasheet

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
- 60	0.0160 at V _{GS} = - 10 V	- 53	38 nC		
- 60	0.0200 at V _{GS} = - 4.5 V	- 42	30 110		

FEATURES

- Trench Power MOSFET
- 100 % UIS Tested

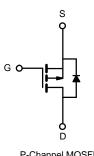
APPLICATIONS

Load Switch





TO-3P



P-Channel	MOSFEI	

ABSOLUTE MAXIMUM RATINGS	S (T _A = 25 °C, unle	ess otherwise no	oted)	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	- 60	V
Gate-Source Voltage		V _{GS}	± 25	v
	T _C = 25 °C		- 53 ^a	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		- 46.8	
Continuous Diain Current $(T_j = 150 \text{ C})$	T _A = 25 °C	I _D	-9.2 ^b	A
	T _A = 70 °C		- 8.1 ^b	
Pulsed Drain Current		I _{DM}	- 200	
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	- 45	
Single Pulse Avalanche Energy	L = 0.1 IIIH	E _{AS}	101	mJ
Continuous Source-Drain Diode Current	T _C = 25 °C		69 ^a	A
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.1 ^b	
	T _C = 25 °C		104.2 ^a	
Maximum Power Dissipation	T _C = 70 °C		66.7 ^a	w
	T _A = 25 °C	P _D —	3.1 ^b	VV
	T _A = 70 °C		2 ^b	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	33	40	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.98	1.2	0/00	

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface mounted on 1" x 1" FR4 board.

SPECIFICATIONS (T _J = 25 °C,	unless othe	erwise noted)					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		68		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η = - 200 μΛ		- 5.2			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Oala Malla an Daria Oana at		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			- 10	μA	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			А	
	5	V _{GS} = - 10 V, I _D = - 30 A		0.0160		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 20 A		0.0200			
Forward Transconductance ^a	g _{fs}	V _{DS} = - 15 V, I _D = - 50 A	20			S	
Dynamic ^b							
Input Capacitance	C _{iss}			3500		pF	
Output Capacitance	C _{oss}	V_{DS} = - 25 V, V_{GS} = 0 V, f = 1 MHz		390			
Reverse Transfer Capacitance	C _{rss}			290			
	Qg	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -55$ A		76	115		
Total Gate Charge				38	60		
Gate-Source Charge	Q _{gs}	Q_{gs} V _{DS} = - 30 V, V _{GS} = - 4.5 V, I _D = - 55 A		16		nC	
Gate-Drain Charge	Q _{gd}			19		1	
Gate Resistance	Rg	f = 1 MHz		5.2		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	V_{DD} = - 2 V, R_L = 2 Ω		7	15		
Turn-Off Delay Time	t _{d(off)}	$I_{D}\cong$ - 10 A, V_{GEN} = - 10 V, R_{g} = 1 Ω		70	110	- ns	
Fall Time	t _f			40	60		
Drain-Source Body Diode Characteristic	s			•			
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 69	•	
Pulse Diode Forward Current ^a	I _{SM}	N			- 150	A	
Body Diode Voltage	V _{SD}	I _S = - 30 A		- 1	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			45	68	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	$Q_{\rm rr}$ $L = 50.4 di/dt 400.4/m T 05.00$		59	120	nC	
Reverse Recovery Fall Time	ta	I _F = - 50 A, di/dt = 100 A/μs, T _J = 25 °C		29		ns	
Reverse Recovery Rise Time	t _b			16			

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

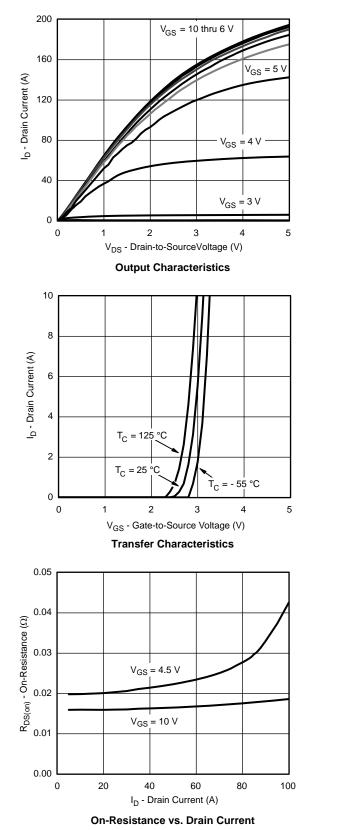
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

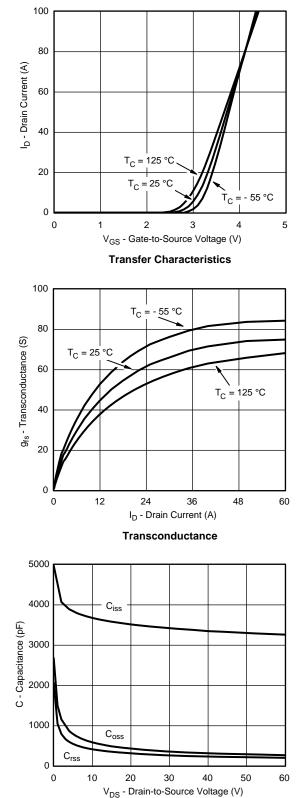
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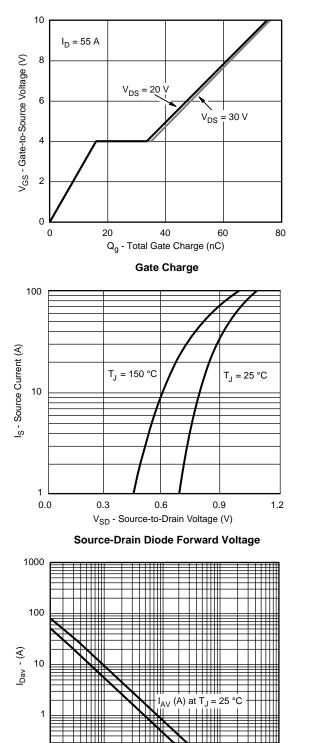


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Capacitance





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $\label{eq:Tin-s} \mathsf{T}_{\text{in}} \text{-} (s)$ Single Pulse Avalanche Current Capability vs. Time

0.01

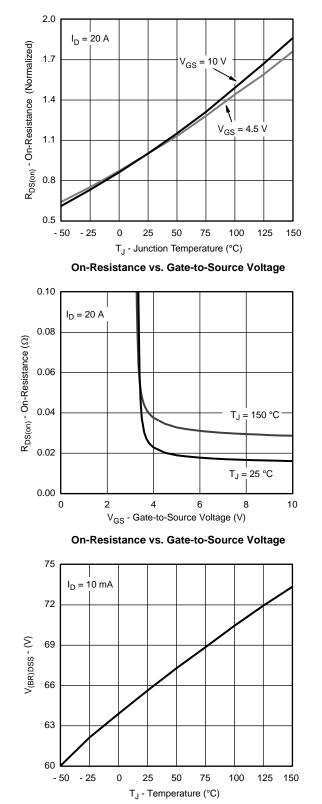
0.1

1

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 I_{AV} (A) at T_{J} = 150

0.001

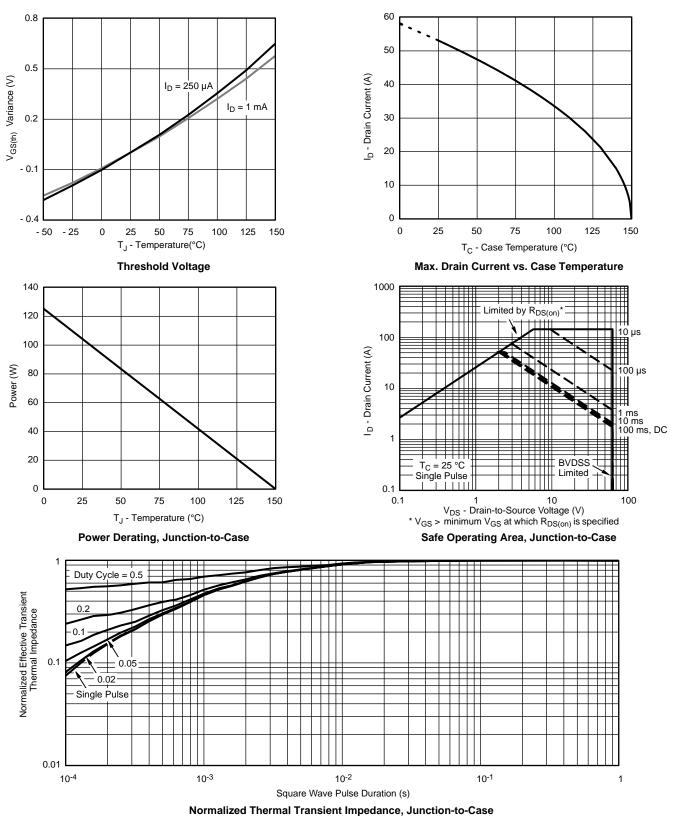


Drain-Source Breakdown Voltage vs. Junction Temperature

0.1

0.0001

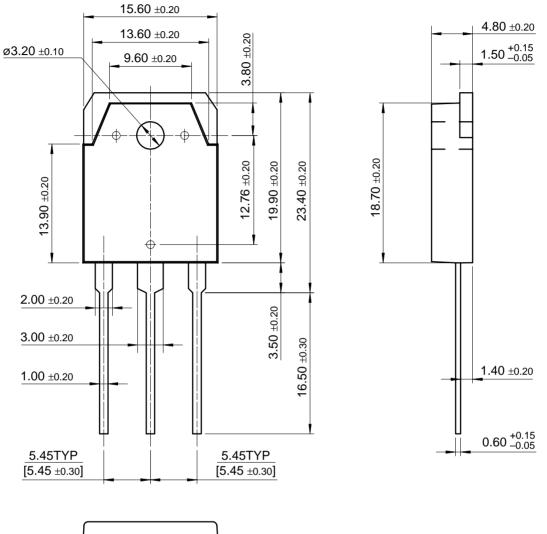


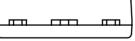


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



TO-3P







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